



Attorney Docket No. 1186.1033

Group Art Unit: 2841

Examiner: Hoa Cao NGUYEN

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Takehito TSUKAMOTO et al.

Application No.: 10/808,502

Confirmation No.: 5712

Filed: March 25, 2004

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MULTI-LAYER WIRING BOARD, IC PACKAGE, AND METHOD OF

MANUFACTURING MULTI-LAYER WIRING BOARD

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

For:

This is responsive to the Office Action mailed March 14, 2006 having a shortened period for response set to expire on April 14, 2006.

Regarding the restriction requirement, Applicants elect claims directed to the invention of Group I, which includes claims 1-2 and 4-34, drawn to a "structure of a multilayer circuit board." Applicants reserve the right to further prosecute without prejudice the non-elected claims 3 and 35-51 and the related invention.

Regarding the election of species requirement, Applicants elect Species (a), that is, claims 1, 2, 21, and 24 all of which are readable on the species. Applicants reserve the right to further prosecute without prejudice the non-elected Species b-d, and the claims readable thereon, and to re-include such claims in this application when a generic claim is held allowable. Presently, the Examiner considers claims 1, 2, 21, and 24 to be generic.

If there are any additional fees associated with this Response, please charge the same to our Deposit Account No. 19-3935.

Respectfully submitted,

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Date: April 12, 2006

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